## Description

The AP7335A is a $300 \mathrm{~mA}, 5.0 \mathrm{~V}$ fixed output voltage, low dropout linear regulator with $\pm 1 \%$ output voltage accuracy. The device included pass element, error amplifier, band-gap, current limit and thermal shutdown circuitry. The device is turned on when EN pin is set to logic high level.

The characteristics of low dropout voltage and low quiescent current make it suitable for low power applications, for example, battery powered devices. The typical quiescent current is $35 \mu \mathrm{~A}$. Built-in current-limit and thermal-shutdown functions prevent IC from damage in fault conditions.
This device is only available as 5.0 V fixed version. Please contact your local sales office for any other voltage options.
The AP7335A is packaged in SOT25 and DFN2020-6.

## Applications

- Smart Phones
- MP3/MP4
- Battery-powered devices
- Bluetooth headset
- Battery Charger
- LCD TV
- Multifunction Monitors


## Pin Assignments



SOT25 (Fixed Output)
DFN2020-6 (Fixed Output)

## Features

- 300 mA Low Dropout Regulator with EN
- Very low $\mathrm{I}_{\mathrm{Q}} 35 \mu \mathrm{~A}$
- Fixed output at 5.0 V
o VIN MIN 5.5 V
- High PSRR: 65 dB at 1 kHz
- Fast start-up time $220 \mu \mathrm{~s}$
- Stable with low ESR, $1 \mu \mathrm{~F}$ ceramic output capacitor
- Excellent Load/Line Transient Response
- Low dropout 150 mV at 300 mA
- Current limit and short circuit protection
- Thermal shutdown protection
- Ambient temperature range $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
- SOT25, and DFN2020-6 Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Note: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.

## Typical Application Circuit



## Fixed Output

## Pin Descriptions

| Pin Name | Pin Number |  | Description |
| :---: | :---: | :---: | :--- |
|  | SOT25 <br> (fixed) | DFN2020-6 <br> (fixed) |  |
| IN | 1 | 3 |  |
| GND | 2 | 2 | Ground |
| EN | 3 | 1 | Enable input, active high |
| ADJ | - | - | Output feedback pin |
| NC | 4 | 5,6 | No connection |
| OUT | 5 | 4 | Voltage output pin. Bypass to ground through 1 $\mu$ F MLCC capacitor |

## Functional Block Diagram



Fixed Version

AP7335A
300mA, LOW QUIESCENT CURRENT, FAST TRANSIENT LOW DROPOUT LINEAR REGULATOR

## Absolute Maximum Ratings

| Symbol | Parameter | Ratings | Unit |
| :---: | :--- | :---: | :---: |
| ESD HBM | Human Body Model ESD Protection | 2000 | V |
| ESD MM | Machine Model ESD Protection | 200 | V |
| $\mathrm{~V}_{\text {IN }}$ | Input Voltage | 6.5 | V |
|  | OUT, EN Voltage | $\mathrm{V}_{\text {IN }}+0.3$ | V |
|  | Continuous Load Current per Channel | Internal Limited |  |
| $\mathrm{T}_{\text {ST }}$ | Storage Temperature Range | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {J }}$ | Maximum Junction Temperature | 150 | ${ }^{\circ} \mathrm{C}$ |

Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

## Recommended Operating Conditions

| Symbol | Parameter | Min | Max | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IN}}$ | Input voltage (Note 3) | 2 (Note 3) | 6 | V |
| $\mathrm{I}_{\text {OUT }}$ | Output Current (Note 2) | 0 | 300 | mA |
| $\mathrm{~T}_{\mathrm{A}}$ | Operating Ambient Temperature | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |

Notes: 2. The device maintains a stable, regulated output voltage without a load current.
3. $\mathrm{V}_{\text {IN(MIN })}=5.5 \mathrm{~V}$ for $5.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}$ at 300 mA IOUT

## Electrical Characteristics

( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{IN}}=5.5$ to $6 \mathrm{~V}, \mathrm{C}_{\text {IN }}=1 \mu \mathrm{~F}, \mathrm{C}_{\mathrm{OUT}}=1 \mu \mathrm{~F}, \mathrm{~V}_{\mathrm{EN}}=2 \mathrm{~V}$, unless otherwise stated)

| Symbol | Parameter | Test Conditions | Min | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| V OUT | Output Voltage Accuracy | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to } 85^{\circ} \mathrm{C}, \\ & \mathrm{I}_{\text {OUT }}=10 \% \text { of } \text { IOUT-Max } \end{aligned}$ | -1 |  | 1 | \% |
| $\Delta V_{\text {OUT }}$ $I \Delta \mathrm{~V}_{\mathrm{IN}} / \mathrm{V}$ | Line Regulation | $\begin{aligned} & \hline \mathrm{V}_{\text {IN }}=5.5 \mathrm{~V} \text { to } 6 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{EN}}=\mathrm{V}_{\text {IN }}, \text { l IOUT } \end{aligned}=1 \mathrm{~mA}$ |  | 0.02 | 0.20 | \%/V |
| $\Delta \mathrm{V}_{\text {OUT }}$ NOUT | Load Regulation | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V} \text { to } 6 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \text { to } 300 \mathrm{~mA} \end{aligned}$ | -0.6 |  | 0.6 | \% |
| $\mathrm{V}_{\text {DROPOUT }}$ | Dropout Voltage (Note 4) | lout $=300 \mathrm{~mA}$ |  | 150 | 200 | mV |
| $\mathrm{I}_{\mathrm{Q}}$ | Input Quiescent Current | $\mathrm{V}_{\text {EN }}=\mathrm{V}_{\text {IN }}, \mathrm{l}_{\text {OUT }}=0 \mathrm{~mA}$ |  | 35 | 80 | $\mu \mathrm{A}$ |
| ISHDN | Input Shutdown Current | $\mathrm{V}_{\text {EN }}=0 \mathrm{~V}$, $\mathrm{l}_{\text {OUT }}=0 \mathrm{~mA}$ |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| l LEAK | Input Leakage Current | $\mathrm{V}_{\text {EN }}=0 \mathrm{~V}$, OUT grounded |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| $\mathrm{t}_{\text {ST }}$ | Start-up Time | $\begin{aligned} & \mathrm{V}_{\mathrm{EN}}=0 \mathrm{~V} \text { to } 2.0 \mathrm{~V} \text { in } 1 \mu \mathrm{~s}, \\ & \mathrm{l}_{\mathrm{OUT}}=300 \mathrm{~mA} \end{aligned}$ |  | 220 |  | $\mu \mathrm{s}$ |
| PSRR | PSRR | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}_{\mathrm{DC}}+0.5 \mathrm{~V}_{\mathrm{ppAC}}, \\ & \mathrm{f}=1 \mathrm{kHz}, \mathrm{l}_{\mathrm{OUT}}=50 \mathrm{~mA} \end{aligned}$ |  | 65 |  | dB |
| ISHORT | Short-circuit Current | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {IN-Min }}$ to $\mathrm{V}_{\text {IN-Max }}$, <br> $\mathrm{V}_{\text {OUT }}<0.2 \mathrm{~V}$ (fixed) or |  | 160 |  | mA |
| ILIMIT | Current limit | $\begin{aligned} & \mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {IN-Min }} \text { to } \mathrm{V}_{\text {IN-Max }}, \\ & \mathrm{V}_{\text {OUT }} / R_{\text {OUT }}=1.2 \mathrm{~A} \end{aligned}$ | 400 | 650 |  | mA |
| $\mathrm{V}_{\text {IL }}$ | EN Input Logic Low Voltage | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {IN-Min }}$ to $\mathrm{V}_{\text {IN-Max }}$ |  |  | 0.4 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | EN Input Logic High Voltage | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {IN-Min }}$ to $\mathrm{V}_{\text {IN-Max }}$ | 1.4 |  |  | V |
| $\mathrm{I}_{\text {EN }}$ | EN Input Current | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ or $\mathrm{V}_{\text {IN-Max }}$ | -1 |  | 1 | $\mu \mathrm{A}$ |
| TSHDN | Thermal shutdown threshold |  |  | 145 |  | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{HYS}}$ | Thermal shutdown hysteresis |  |  | 15 |  | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\text {JA }}$ | Thermal Resistance Junction-to-Ambient | SOT25 (Note 5) |  | 187 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | DFN2020-6 (Note 5) |  | 251 |  |  |

Notes: 4. Dropout voltage is the voltage difference between the input and the output at which the output voltage drops $1 \%$ below its nominal value. 5. Test condition for all packages: Device mounted on FR-4 substrate PC board, $10 z$ copper, with minimum recommended pad layout.

AP7335A
300mA, LOW QUIESCENT CURRENT, FAST TRANSIENT LOW DROPOUT LINEAR REGULATOR

## Typical Performance Characteristics

Start-Up Time


Line Transient Response


Load Transient Response



Line Transient Response


Load Transient Response
 AP7335A 300mA, LOW QUIESCENT CURRENT, FAST TRANSIENT LOW DROPOUT LINEAR REGULATOR

Typical Performance Characteristics (cont.)





AP7335A
300mA，LOW QUIESCENT CURRENT，FAST TRANSIENT LOW DROPOUT LINEAR REGULATOR

## Application Note

## Input Capacitor

A $1 \mu \mathrm{~F}$ ceramic capacitor is recommended between IN and GND pins to decouple input power supply glitch and noise． The amount of the capacitance may be increased without limit．This input capacitor must be located as close as possible to the device to assure input stability and reduce noise．For PCB layout，a wide copper trace is required for both IN and GND pins．A lower ESR capacitor type allows the use of less capacitance，while higher ESR type requires more capacitance．

## Output Capacitor

The output capacitor is required to stabilize and improve the transient response of the LDO．The AP7335A is stable with very small ceramic output capacitors．Using a ceramic capacitor value that is at least $1 \mu \mathrm{~F}$ with ESR $>15 \mathrm{~m} \Omega$ on the output ensures stability．Higher capacitance values help to improve line and load transient response．The output capacitance may be increased to keep low undershoot and overshoot．Output capacitor must be placed as close as possible to OUT and GND pins．


## No Load Stability

No minimum load is required to keep the device stable． The device will remain stable and regulated in no load condition．

## ON／OFF Input Operation

The AP7335A is turned on by setting the EN pin high，and is turned off by pulling it low．If this feature is not used，the EN pin should be tied to IN pin to keep the regulator output on at all time．To ensure proper operation，the signal source used to drive the EN pin must be able to swing above and below the specified turn－on／off voltage thresholds listed in the Electrical Characteristics section under $\mathrm{V}_{\mathrm{IL}}$ and $\mathrm{V}_{\mathrm{IH}}$ ．

## Current Limit Protection

When output current at OUT pin is higher than current limit threshold，the current limit protection will be triggered and clamp the output current to approximately 650 mA to prevent over－current and to protect the regulator from damage due to overheating．

## Short Circuit Protection

When OUT pin is short－circuit to GND，short circuit protection will be triggered and clamp the output current to approximately 160 mA ．This feature protects the regulator from over－current and damage due to overheating．

## Thermal Shutdown Protection

Thermal protection disables the output when the junction temperature rises to approximately $+145^{\circ} \mathrm{C}$ ，allowing the device to cool down．When the junction temperature reduces to approximately $+130^{\circ} \mathrm{C}$ the output circuitry is enabled again．Depending on power dissipation， thermal resistance，and ambient temperature，the thermal protection circuit may cycle on and off． This cycling limits the heat dissipation of the regulator， protecting it from damage due to overheating．

## Ultra Fast Start－up

After enabled，the AP7335A is able to provide full power in as little as tens of microseconds，typically $220 \mu \mathrm{~s}$ ， without sacrificing low ground current．This feature will help load circuitry move in and out of standby mode in real time，eventually extend battery life for mobile phones and other portable devices．

## Fast Transient Response

Fast transient response LDO can extend battery life． TDMA－based cell phone protocols such as Global System for Mobile Communications（GSM）have a transmit／receive duty factor of only 12.5 percent，enabling power savings by putting much of the baseband circuitry into standby mode in between transmit cycles．In baseband circuits，the load often transitions virtually instantaneously from $100 \mu \mathrm{~A}$ to 100 mA ．To meet this load requirement，the LDO must react very quickly without a large voltage drop or overshoot－a requirement that cannot be met with conventional，general－purpose LDO．

The AP7335A＇s fast transient response from 0 to 300 mA provides stable voltage supply for fast DSP and GSM chipset with fast changing load．

## Low Quiescent Current

The AP7335A，consuming only around $35 \mu \mathrm{~A}$ for all input range，provides great power saving in portable and low power applications．

## Application Note (cont.)

## Power Dissipation

The device power dissipation and proper sizing of the thermal plane that is connected to the thermal pad is critical to avoid thermal shutdown and ensure reliable operation. Power dissipation of the device depends on input voltage and load conditions and can be calculated by:

$$
P_{D}=\left(V_{\text {IN }}-V_{\text {OUT }}\right) \times \text { IOUT }
$$

The maximum power dissipation, handled by the device, depends on the maximum junction to ambient thermal resistance, maximum ambient temperature, and maximum device junction temperature, which can be calculated by the following equation:

$$
P_{D}\left(\max @ T_{A}\right)=\frac{\left(+145^{\circ} \mathrm{C}-T_{A}\right)}{R_{\theta J A}}
$$

## Ordering Information




Note: $\quad 6$. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at
http://www.diodes.com/datasheets/ap02001.pdf.

## Marking Information

(1) SOT25

| Top View ) |  |  |  |
| :---: | :---: | :---: | :---: |
| 5 |  | 4 |  |
| $\underline{X X} \underline{Y} \underline{W} \underline{X}$ |  |  | XX : Identification code <br> Y: Year 0~9 <br> W : Week : A~Z : 1~26 week; a~z: 27~52 week; z represents 52 and 53 week <br> X: A~Z : G = Green |
| 1 | 2 | 3 |  |


| Device | Package | Identification Code |
| :---: | :---: | :---: |
| AP7335A-50 | SOT25 | TP |

(2) DFN2020-6
(Top View)

| $\underline{X X}$ | XX : Identification Code <br> Y: Year: 0~9 |
| :---: | :---: |
| $\underline{Y} \underline{W} \underline{X}$ | $\underline{\text { W }}$ : Week : A $-Z: 1 \sim 26$ week; |


| Device | Package | Identification Code |
| :---: | :---: | :---: |
| AP7335A-50 | DFN2020-6 | TP |

## Package Outline Dimensions (cont.)

(1) Package Type: SOT25

(2) Package Type: DFN2020-6


## Taping Orientation (Note 7)

For DFN2020-6


Note: 7. The taping orientation of the other package type can be found on our website at http://www.diodes.com/datasheets/ap02007.pdf.

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